



N- and P-Channel 30 V (D-S) MOSFET

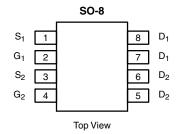
PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
N-Channel	30	0.053 at V _{GS} = 10 V	4.9			
N-Channel		0.075 at V _{GS} = 4.5 V	4.1			
P-Channel	- 30	0.080 at V _{GS} = - 10 V	- 3.9			
r-Channel		0.135 at V _{GS} = - 4.5 V	- 3.0			

FEATURES

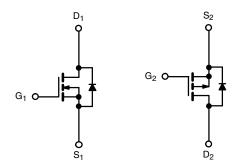
- Halogen-free According to IEC 61249-2-21 **Available**
- TrenchFET® Power MOSFETs
- 100 % R_a Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE



Ordering Information: Si4532ADY-T1-E3 (Lead (Pb-free) Si4532ADY-T1-GE3 (Lead (Pb-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
		Symbol	N-Channel		P-Channel		
Parameter	10 s		Steady State	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		- 30		V
Gate-Source Voltage		V_{GS}	± 20		± 20		V
Continuous Prain Current /T 150 °C\a	T _A = 25 °C	- I _D	4.9	3.7	- 3.9	- 3.0	А
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		3.9	2.9	- 3.1	- 2.4	
Pulsed Drain Current		I _{DM}		^			
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.94	- 1.7	- 1.0	
Mariana Bana Biada di ad	T _A = 25 °C	P _D	2	1.13	2	1.2	W
Maximum Power Dissipation ^a	T _A = 70 °C		1.3	0.73	1.3	0.76	
Operating Junction and Storage Temperature	T _J , T _{stg}		°C				

THERMAL RESISTANCE RATINGS									
		N-Channel		P-Channel					
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit		
Marrian In action to Amelianta	t ≤ 10 s	R _{thJA}	55	62.5	54	62.5			
Maximum Junction-to-Ambient ^a	Steady State	¹¹thJA	90	110	87	105	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	40	50	34	45			

a. Surface mounted on 1" x 1" FR4 board.

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SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Cata Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	1			V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 1				
0.0	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	A	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	P-Ch			± 100	nA	
		V _{DS} = 30 V, V _{GS} = 0 V	N-Ch			1		
Zava Cata Valtaga Drain Current		V _{DS} = - 30 V, V _{GS} = 0 V	P-Ch			- 1	- μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	N-Ch			5		
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch			- 5		
	ı	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 20			Α	
		V _{GS} = 10 V, I _D = 4.9 A	N-Ch		0.044	0.053	Ω	
Duale Course On Otata Desistance	R	V _{GS} = - 10 V, I _D = - 3.9 A	P-Ch		0.062	0.080		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.1 A	N-Ch		0.062	0.075	22	
		V _{GS} = - 4.5 V, I _D = - 3 A	P-Ch		0.105	0.135		
- IT I A	9 _{fs}	V _{DS} = 15 V, I _D = 4.9 A	N-Ch		11		s	
Forward Transconductance ^a		V _{DS} = - 15 V, I _D = - 2.5 A	P-Ch		5		3	
Die de Fernand Valle and	V	I _S = 1.7 A, V _{GS} = 0 V	N-Ch		0.80	1.2	V	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.7 A, V _{GS} = 0 V	P-Ch	- 0.82		- 1.2	V	
Dynamic ^b								
Total Gate Charge	Qg	N. Observati	N-Ch		8	16		
Total date charge		N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.9 \text{ A}$	P-Ch		10	20	nC	
Gate-Source Charge	Q_{gs}		N-Ch		1.4			
	P-Channel		P-Ch N-Ch		1,2		-	
Gate-Drain Charge	Q_{gd}	$V_{DS} = -4 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.9 \text{ A}$	P-Ch		1.2			
			N-Ch	0.4	1.6	3.2		
Gate Resistancee	R_g	f = 1 MHz	P-Ch	1.5	6.2	12	Ω	
Tive On Delay Time	t _{d(on)}		N-Ch		12	20		
Turn-On Delay Time		N-Channel $V_{DD} = 10 \text{ V}, R_1 = 10 \Omega$	P-Ch		8	15		
Rise Time		$I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_q = 6 \Omega$	N-Ch		10	20		
-	1D = 1 A, VGEN - 10 V, 11g = 0 22		P-Ch		9	18		
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch P-Ch		23 21	45 40	ns	
	t _f	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$	N-Ch		8	15	-	
Fall Time		$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 6 Ω	P-Ch		10	20		
·		I _F = 1.7 A, dI/dt = 100 A/μs	N-Ch		25	40		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.7 A, dl/dt = 100 A/μs	P-Ch		27	40		

Notes:

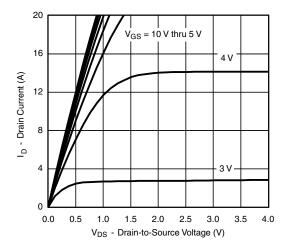
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

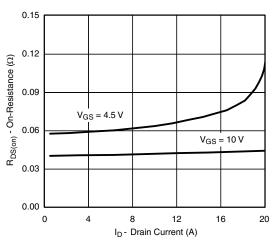
b. Guaranteed by design, not subject to production testing.



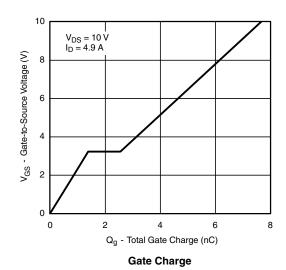
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

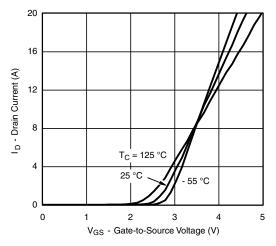


Output Characteristics

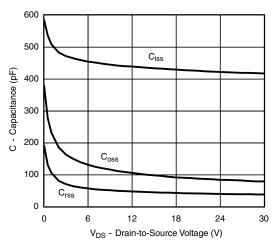


On-Resistance vs. Drain Current

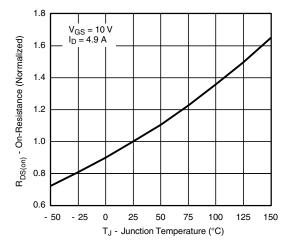




Transfer Characteristics



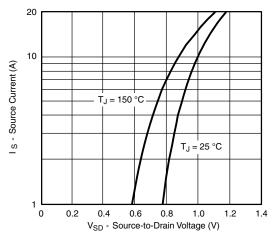
Capacitance



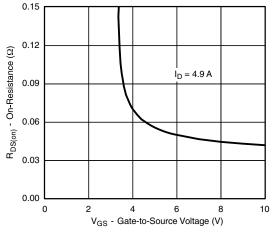
On-Resistance vs. Junction Temperature

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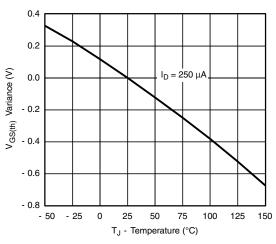
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



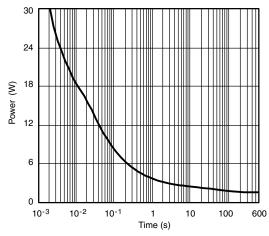
Source-Drain Diode Forward Voltage



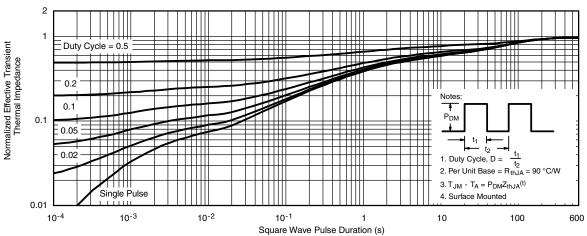
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



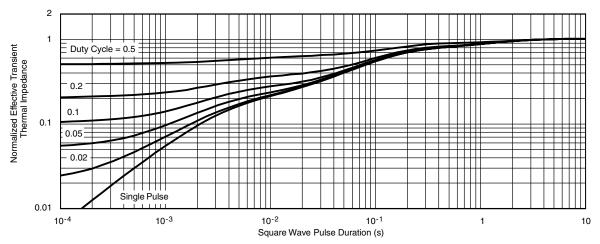
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

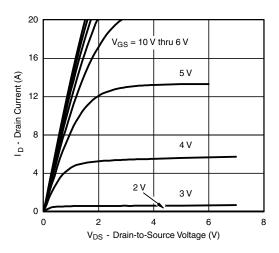


N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

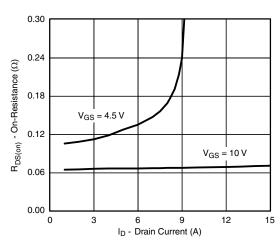


Normalized Thermal Transient Impedance, Junction-to-Foot

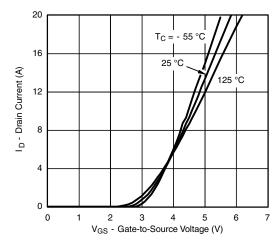
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



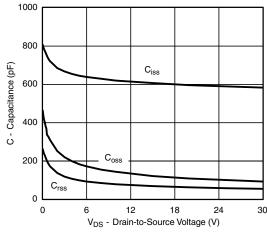
Output Characteristics



On-Resistance vs. Drain Current



Transfer Characteristics

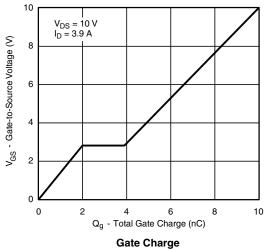


Capacitance

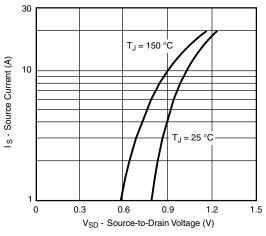
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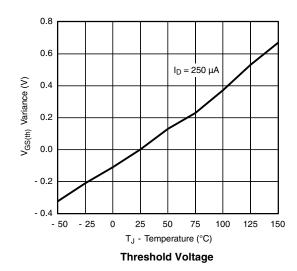
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

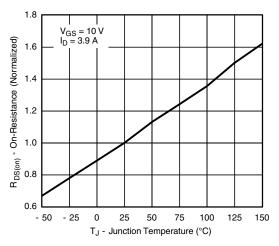




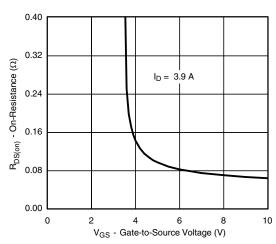


Source-Drain Diode Forward Voltage

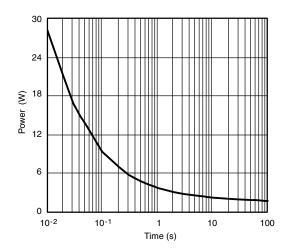




On-Resistance vs. Junction Temperature



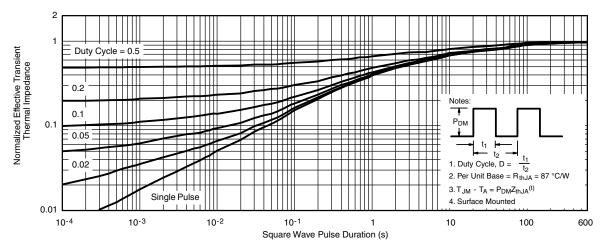
On-Resistance vs. Gate-to-Source Voltage



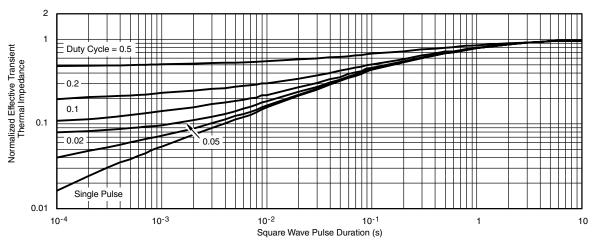
Single Pulse Power, Junction-to-Ambient



P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

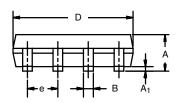
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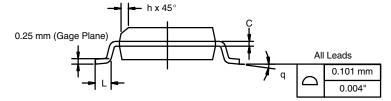
Document Number: 71133 S11-1908-Rev. D, 26-Sep-11



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	HES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

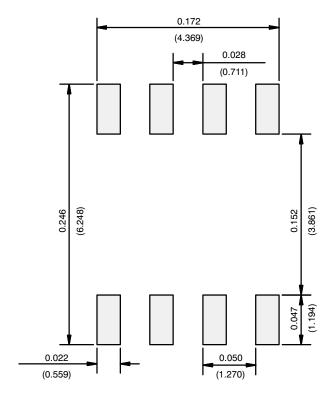
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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